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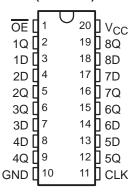
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Support Unregulated Battery Operation Down to 2.7 V
- I_{off} and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)

description/ordering information

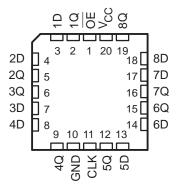
These octal flip-flops are designed specifically for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment.

The eight flip-flops of the 'LVTH374 devices are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

SN54LVTH374...J OR W PACKAGE SN74LVTH374...DB, DW, NS, OR PW PACKAGE (TOP VIEW)



SN54LVTH374 . . . FK PACKAGE (TOP VIEW)



ORDERING INFORMATION

TA	PACK	AGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0010 PW	Tube	SN74LVTH374DW	1.VT1107.4
	SOIC - DW	Tape and reel	SN74LVTH374DWR	LVTH374
4000 / 0500	SOP - NS	Tape and reel	SN74LVTH374NSR	LVTH374
−40°C to 85°C	SSOP – DB	Tape and reel	SN74LVTH374DBR	LXH374
	TOOOD DW	Tube	SN74LVTH374PW	1.7/1/07/4
	TSSOP – PW	Tape and reel	SN74LVTH374PWR	LXH374
	CDIP – J	Tube	SNJ54LVTH374J	SNJ54LVTH374J
–55°C to 125°C	CFP – W	Tube	SNJ54LVTH374W	SNJ54LVTH374W
	LCCC - FK	Tube	SNJ54LVTH374FK	SNJ54LVTH374FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



processing does not necessarily include testing of all pa

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description/ordering information (continued)

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

OE does not affect the internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

When V_{CC} is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

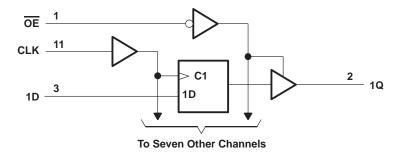
Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

These devices are fully specified for hot-insertion applications using Ioff and power-up 3-state. The Ioff circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

FUNCTION TABLE (each flip-flop)

	OUTPUT		
OE	CLK	D	Q
L	\uparrow	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q_0
Н	X	Χ	Z

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
or power-off state, V _O (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state, VO (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Current into any output in the low state, IO: SN54LVTH374	96 mA
SN74LVTH374	128 mA
Current into any output in the high state, IO (see Note 2): SN54LVTH374	48 mA
SN74LVTH374	64 mA
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 3): DB package	70°C/W
DW package	58°C/W
NS package	
PW package	83°C/W
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. This current flows only when the output is in the high state and $V_O > V_{CC}$.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

		SN54LVTH374		SN74LV		
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	2.7	3.6	2.7	3.6	V
V _{IH}	High-level input voltage	2		2		V
VIL	Low-level input voltage		0.8		8.0	V
VI	Input voltage		5.5		5.5	V
loh	High-level output current		-24		-32	mA
loL	Low-level output current		48		64	mA
Δt/Δν	Input transition rise or fall rate		10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate	200		200		μs/V
T _A	Operating free-air temperature	-55	125	-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		
$V_{OH} = \begin{array}{ c c c c c c c c } \hline V_{CC} & & V_{CC} & V_{$	UNIT	
Voh	V	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		
VCC = 3 V	V	
$V_{OL} = \frac{10 - 3 \cdot m}{V_{CC} = 2.7 V} = \frac{I_{OL} = 100 \mu A}{I_{OL} = 100 \mu A} = \frac{0.2}{0.5} = \frac{0.2}{0.5}$ $\frac{I_{OL} = 100 \mu A}{I_{OL} = 24 m A} = \frac{0.5}{0.5} = \frac{0.5}{0.5}$ $\frac{I_{OL} = 16 m A}{I_{OL} = 32 m A} = \frac{0.5}{0.5} = \frac{0.5}{0.5}$ $\frac{I_{OL} = 48 m A}{I_{OL} = 64 m A} = \frac{0.5}{0.55}$ $\frac{Control}{inputs} = \frac{V_{CC} = 0 or 3.6 V}{V_{CC} = 3.6 V} = \frac{V_{I} = V_{CC} or GND}{V_{I} = V_{CC}} = \frac{1}{1} = \frac{1}{1}$ $\frac{Data}{inputs} = \frac{V_{CC} = 3.6 V}{V_{CC} = 3.6 V} = \frac{V_{I} = V_{CC}}{V_{I} = 0} = \frac{1}{1} = \frac{1}{1}$ $\frac{I_{I}(hold)}{inputs} = \frac{V_{CC} = 3.6 V}{V_{CC} = 3.6 V} = \frac{V_{I} = 0.8 V}{V_{I} = 2.0 V} = \frac{75}{1000} = \frac{75}{1000}$ $\frac{V_{CC} = 3.6 V^{\ddagger}}{V_{CC} = 3.6 V} = \frac{V_{I} = 0 to 3.6 V}{V_{I} = 2.0 V} = \frac{500}{-750}$ $\frac{I_{OZH}}{I_{OZPU}} = \frac{V_{CC} = 3.6 V}{V_{CC} = 3.6 V} = \frac{V_{O} = 0.5 V to 3.V}{V_{O} = 0.5 V to 3.V} = \frac{5}{1000}$ $\frac{V_{CC}}{I_{OE}} = 1.5 V to 0, V_{O} = 0.5 V to 3.V}{I_{OE}} = \frac{1}{1000} = \frac{1}{1000} = \frac{1}{1000} = \frac{1}{1000} = \frac{1}{1000} = \frac{1}{10000} = \frac{1}{100000} = \frac{1}{10000000000000000000000000000000000$	V	
Vol		
VOL VOL VOC = 3 V IOL = 24 mA O.5 O		
$\begin{array}{ c c c c c c } \hline V_{OL} & V_{CC} = 3 \ V & \hline & I_{OL} = 32 \ mA & 0.5 & 0.5 \\ \hline & I_{OL} = 48 \ mA & 0.55 \\ \hline & I_{OL} = 64 \ mA & 0.55 \\ \hline & I_{OL} = 64 \ mA & 0.55 \\ \hline & I_{OL} = 64 \ mA & 0.55 \\ \hline & I_{OL} = 64 \ mA & 0.55 \\ \hline & I_{OL} = 64 \ mA & 0.55 \\ \hline & I_{OL} = 64 \ mA & 0.55 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.19 \\ \hline & I_{OL} = 10 \ math & 0.10 \ math & 0.10 \\ \hline & I_{OL} =$		
$ \begin{array}{ c c c c c c c } & V_{CC} = 3 \ V & \begin{array}{ c c c c c c c c c c c c c c c c c c c$	V	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	V	
$ I_{\text{I}} = \begin{array}{ c c c c c } \hline & V_{\text{CC}} = 0 \text{ or } 3.6 \text{ V}, & V_{\text{I}} = 5.5 \text{ V} & 10 & 10 \\ \hline & Control & V_{\text{CC}} = 3.6 \text{ V}, & V_{\text{I}} = V_{\text{CC}} \text{ or GND} & \pm 1 & \pm 1 \\ \hline & Data & \\ & \text{inputs} & V_{\text{CC}} = 3.6 \text{ V} & \hline & V_{\text{I}} = V_{\text{CC}} & 1 & 1 & 1 \\ \hline & V_{\text{I}} = 0 & -5 & -5 & -5 \\ \hline I_{\text{Off}} & V_{\text{CC}} = 0, & V_{\text{I}} \text{ or } V_{\text{O}} = 0 \text{ to } 4.5 \text{ V} & \pm 100 \\ \hline & V_{\text{I}} = 0 & V_{\text{CC}} = 3 \text{ V} & V_{\text{I}} = 0 \text{ to } 3.6 \text{ V} & 75 & 75 \\ \hline & V_{\text{I}} = 2 \text{ V} & -75 & -75 & -75 \\ \hline I_{\text{OZH}} & V_{\text{CC}} = 3.6 \text{ V}, & V_{\text{I}} = 0 \text{ to } 3.6 \text{ V} & 5 & 5 \\ \hline I_{\text{OZH}} & V_{\text{CC}} = 3.6 \text{ V}, & V_{\text{O}} = 3 \text{ V} & 5 & 5 \\ \hline I_{\text{OZPU}} & V_{\text{CC}} = 3.6 \text{ V}, & V_{\text{O}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & \pm 100^* \\ \hline I_{\text{OZPD}} & V_{\text{CC}} = 3.6 \text{ V}, & V_{\text{O}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & \pm 100^* \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & V_{\text{O}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & \pm 100^* \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & V_{\text{O}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & \pm 100^* \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{O}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & \pm 100^* \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & \pm 100^* \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{\text{CC}} & V_{\text{CC}} = 3.6 \text{ V}, & O_{\text{CD}} = 0.5 \text{ V} \text{ to } 3 \text{ V}, & 0.19 \\ \hline I_{$		
$ \begin{array}{ c c c c c c } \hline I_{I} & \hline {Control} & V_{CC} = 3.6 V, & V_{I} = V_{CC} \text{or GND} & \pm 1 & \pm 1 \\ \hline Data & V_{CC} = 3.6 V & \hline V_{I} = V_{CC} & 1 & 1 & 1 \\ \hline I_{I} & V_{CC} = 3.6 V & \hline V_{I} = 0 & -5 & -5 \\ \hline I_{Off} & V_{CC} = 0, & V_{I} \text{or } V_{O} = 0 \text{to } 4.5 V \\ \hline I_{I} & V_{CC} = 3 V & \hline V_{I} = 0.8 V & 75 & 75 \\ \hline V_{I} = 2 V & -75 & -75 \\ \hline I_{OZH} & V_{CC} = 3.6 V, & V_{I} = 0 \text{to } 3.6 V \\ \hline I_{OZPU} & \hline V_{CC} = 3.6 V, & V_{O} = 3 V & 5 & 5 \\ \hline I_{OZPU} & \hline V_{CC} = 3.6 V, & V_{O} = 0.5 V \text{to } 3 V, & \pm 100^* \\ \hline I_{OZPD} & \hline V_{CC} = 3.6 V, & V_{O} = 0.5 V \text{to } 3 V, & \pm 100^* \\ \hline I_{OZPD} & \hline V_{CC} = 3.6 V, & \hline V_{CC} = 3.6 V, & \hline V_{CC} = 0.5 V \text{to } 3 V, & \pm 100^* \\ \hline I_{CC} & \hline V_{CC} = 3.6 V, & \hline V_{CC} = 3.6 V, & \hline V_{CC} = 0.5 V \text{to } 3 V, & \pm 100^* \\ \hline I_{CC} & \hline V_{CC} = 3.6 V, & \hline V_{CC} = $		
$\begin{array}{ c c c c c }\hline I_1 & & & & & & & & & & & & & & & & & & &$		
$\begin{array}{ c c c c c c }\hline & Data & VCC = 3.6 \ V & \hline & V_I = VCC & 1 & 1 & 1 \\ \hline & V_I = 0 & -5 & -5 & -5 \\ \hline & Ioff & VCC = 0, & V_I \text{ or } V_O = 0 \text{ to } 4.5 \ V & & \pm 100 \\ \hline & I_{I(hold)} & Data & VCC = 3 \ V & \hline & V_I = 0.8 \ V & 75 & 75 \\ \hline & V_{I} = 2 \ V & -75 & -75 \\ \hline & IOZH & VCC = 3.6 \ V^{\ddagger}, & V_I = 0 \text{ to } 3.6 \ V & & 5 & 5 \\ \hline & IOZL & VCC = 3.6 \ V, & V_O = 3 \ V & 5 & 5 \\ \hline & IOZPU & \hline & V_CC = 0 \text{ to } 1.5 \ V, V_O = 0.5 \ V \text{ to } 3 \ V, \\ \hline & IOZPD & \hline & V_{CC} = 1.5 \ V \text{ to } 0, V_O = 0.5 \ V \text{ to } 3 \ V, \\ \hline & IOZPO & \hline & V_{CC} = 3.6 \ V, & \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_I = 0 \ U_I = 0, \\ \hline & U_I = 0 \ U_$	μА	
$ \begin{array}{ c c c c c c } \hline loff & V_{CC} = 0, & V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5 \text{ V} \\ \hline \\ l_{I}(\text{hold}) & Data \\ inputs & V_{CC} = 3 \text{ V} & V_{I} = 0 \text{ to } 3.6 \text{ V} \\ \hline \\ V_{CC} = 3.6 \text{ V}^{\ddagger}, & V_{I} = 0 \text{ to } 3.6 \text{ V} \\ \hline \\ l_{OZH} & V_{CC} = 3.6 \text{ V}, & V_{O} = 3.7 \text{ V} \\ \hline \\ l_{OZL} & V_{CC} = 3.6 \text{ V}, & V_{O} = 0.5 \text{ V} \\ \hline \\ l_{OZPD} & V_{CC} = 0 \text{ to } 1.5 \text{ V}, V_{O} = 0.5 \text{ V} \text{ to } 3 \text{ V}, \\ \hline \\ l_{OZPD} & V_{CC} = 1.5 \text{ V to } 0, V_{O} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & V_{CC} = 3.6 \text{ V}, & O_{CC} = 0.5 \text{ V to } 3 \text{ V}, \\ \hline \\ l_{CC} & O_{CC} & O_$	·	
$\begin{array}{ c c c c c c }\hline & & & & & & & & & & & & & & & & & & &$		
$ \begin{array}{ c c c c c c } \hline I_{I}(hold) & Data & V_{CC} = 3 \ V & \hline \\ \hline I_{I}(hold) & Data & V_{CC} = 3.6 \ V^{\ddagger}, & V_{I} = 0 \ to \ 3.6 \ V & \hline \\ \hline I_{OZH} & V_{CC} = 3.6 \ V, & V_{O} = 3 \ V & 5 & 5 \\ \hline I_{OZL} & V_{CC} = 3.6 \ V, & V_{O} = 0.5 \ V & -5 & -5 \\ \hline I_{OZPU} & \hline \\ \hline I_{OZPU} & \hline \\ \hline \\ \hline I_{OZPD} & \hline \\ \hline$	μΑ	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	μA	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	μ	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	μΑ	
IOZPU \overline{OE} = don't care $\pm 100^\circ$ $\pm 100^\circ$ IOZPD $\frac{V_{CC}}{OE}$ = 1.5 V to 0, V_{O} = 0.5 V to 3 V, $\frac{100^\circ}{OE}$ = don't care $\pm 100^\circ$ $\pm 100^\circ$ V _{CC} = 3.6 V, I _O = 0, Outputs high Outputs low 0.19 0.19 I _{CC} I _O = 0, Outputs low 5	μΑ	
	μΑ	
I_{CC} $I_{O} = 0$, Outputs low 5	μΑ	
I_{CC} $I_{O} = 0$, Outputs low 5		
	mA	
V _I = V _{CC} or GND Outputs disabled 0.19 0.19		
ΔI_{CC} $V_{CC} = 3 \text{ V to } 3.6 \text{ V, One input at } V_{CC} - 0.6 \text{ V,}$ Other inputs at V_{CC} or GND 0.2	mA	
C _i V _I = 3 V or 0 3	pF	
C_0 $V_0 = 3 \text{ V or } 0$ 7	pF	

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



[†] All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

[§] This is the increase in supply current for each input that is at the specified TTL voltage level, rather than VCC or GND.

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

			SN54LVTH374		374 SN7		SN74L\	/TH374		
		V _{CC} =	3.3 V 3 V	VCC =	2.7 V	V _{CC} =	3.3 V 3 V	VCC =	2.7 V	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency		150		150		150		150	MHz
t _W	Pulse duration, CLK high or low	3.3		3.3		3.3		3.3		ns
t _{su}	Setup time, data before CLK↑	1.6		2		1.5		2		ns
th	Hold time, data after CLK↑	0.8		0.5		0.8	•	0		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

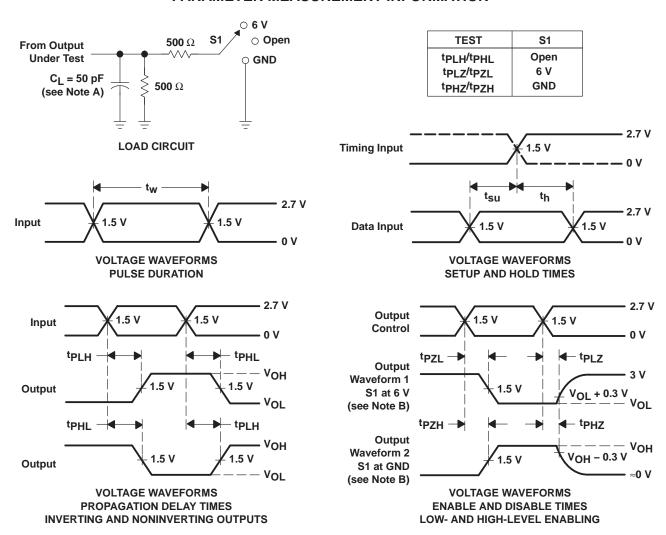
			SN54LVTH374				SN74LVTH374					
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		V_{CC} = 3.3 V \pm 0.3 V			V _{CC} = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	MIN	TYP [†]	MAX	MIN	MAX	
f _{max}			150		150		150			150		MHz
t _{PLH}	OL K	0	1	5.1		5.6	1.8	2.9	4.5		5	
t _{PHL}	CLK	Q	1.5	5.1		5.2	1.8	2.9	4.2		4.3	ns
^t PZH	ŌĒ	_	0.8	5.6		6.6	1.3	2.8	4.7		5.6	
tPZL	OE	Q	1.2	5.4		6.2	1.6	3	4.7		5.2	ns
t _{PHZ}		0	1.5	5.6		5.7	1.9	3	4.6	·	4.9	20
t _{PLZ}	ŌĒ	Q	0.8	5.2		5.3	2	3.1	4.5	·	4.6	ns

 $[\]overline{\dagger}$ All typical values are at V_{CC} = 3.3 V, T_A = 25°C.



SCBS683H - MARCH 1997 - REVISED OCTOBER 2003

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C₁ includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_Q = 50 \ \Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM



ti.com 5-May-2005

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9951001Q2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9951001QRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9951001QSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
SN74LVTH374DBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI
SN74LVTH374DBR	ACTIVE	SSOP	DB	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH374DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH374DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH374NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH374PW	ACTIVE	TSSOP	PW	20	70	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74LVTH374PWE4	ACTIVE	TSSOP	PW	20	70	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74LVTH374PWLE	OBSOLETE	TSSOP	PW	20		TBD	Call TI	Call TI
SN74LVTH374PWR	ACTIVE	TSSOP	PW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74LVTH374PWRE4	ACTIVE	TSSOP	PW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SNJ54LVTH374FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LVTH374J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LVTH374W	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

5-May-2005

t may and
n no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by To Customer on an annual basis.

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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